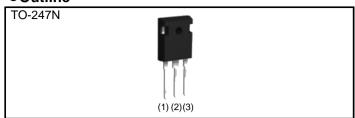


RGS80TSX2

1200V 40A Field Stop Trench IGBT

V _{CES}	1200V
I _{C (100°C)}	40A
V _{CE(sat) (Typ.)}	1.7V
P_D	555W

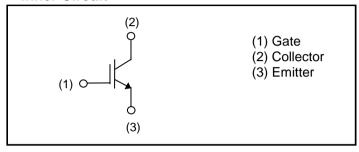
Outline



Features

- 1) Low Collector Emitter Saturation Voltage
- 2) Short Circuit Withstand Time 10µs
- 3) Pb free Lead Plating; RoHS Compliant

●Inner Circuit



Packaging Specifications

or dokaging opcompations					
	Packaging	Tube			
	Reel Size (mm)	-			
Type	Tape Width (mm)	-			
Туре	Basic Ordering Unit (pcs)	450			
	Packing Code	C11			
	Marking	RGS80TSX2			
	-				

Application

PFC

UPS

ΙH

Power Conditioner

● Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		V _{CES}	1200	V
Gate - Emitter Voltage		V_{GES}	±30	V
Collector Current	T _C = 25°C	I _C	80	А
	T _C = 100°C	I _C	40	А
Pulsed Collector Current		I _{CP} *1	120	Α
Dawar Dissipation	T _C = 25°C	P _D	555	W
Power Dissipation	T _C = 100°C	P _D	277	W
Operating Junction Temperatu	re	T _j	-40 to +175	°C
Storage Temperature		T _{stg}	-55 to +175	°C

^{*1} Pulse width limited by T_{imax.}

●Thermal Resistance

Parameter	Symbol	Values			Unit
raidilletei		Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	0.27	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Linit
			Min.	Тур.	Max.	Unit
Collector - Emitter Breakdown Voltage	BV _{CES}	$I_{C} = 10 \mu A, V_{GE} = 0 V$	1200	-	-	V
		$V_{CE} = 1200V, V_{GE} = 0V,$				
Collector Cut - off Current	I _{CES}	$T_{j} = 25^{\circ}C$ $Tj = 175^{\circ}C^{*2}$	-	-	10	μΑ
		Tj = 175°C ^{*2}	-	3	-	mA
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, V_{CE} = 0V$	-	-	±500	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5V, I_{C} = 6.1mA$	5.0	6.0	7.0	V
		$I_C = 40A, V_{GE} = 15V,$				
Collector - Emitter Saturation Voltage	V _{CE(sat)}	T _j = 25°C	-	1.70	2.10	V
		T _j = 175°C	-	2.20	-	V

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Davamatan	Symbol	Conditions		l locit		
Parameter			Min.	Тур.	Max.	Unit
Input Capacitance	C _{ies}	$V_{CE} = 30V$,	-	2820	-	pF
Output Capacitance	C _{oes}	$V_{GE} = 0V$,	-	161	-	
Reverse transfer Capacitance	C _{res}	f = 1MHz	-	25	-	
Total Gate Charge	Q_g	V _{CE} = 500V,	-	104	-	
Gate - Emitter Charge	Q_ge	$I_C = 40A$,	ı	25	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	42	-	
Turn - on Delay Time	t _{d(on)}		-	49	-	
Rise Time	t _r	$I_C = 40A, V_{CC} = 600V,$ $V_{GE} = 15V, R_G = 10\Omega,$	-	27	-	no
Turn - off Delay Time	t _{d(off)}	$T_i = 25^{\circ}C$	-	199	-	ns
Fall Time	t _f	Inductive Load	-	227	-	
Turn - on Switching Loss	E _{on}	*E _{on} include diode reverse recovery	-	3.00	-	mJ
Turn - off Switching Loss	E _{off}		-	3.10	-	
Turn - on Delay Time	t _{d(on)}		-	49	-	
Rise Time	t _r	$I_C = 40A, V_{CC} = 600V,$ $V_{GE} = 15V, R_G = 10\Omega,$	-	40	-	ns
Turn - off Delay Time	t _{d(off)}	$T_i = 175^{\circ}C$	-	258	-	
Fall Time	t _f	Inductive Load	-	371	-	
Turn - on Switching Loss	E _{on}	*E _{on} include diode reverse recovery	-	3.80	-	mJ
Turn - off Switching Loss	E _{off}	,	-	4.50	-	IIIJ
Reverse Bias Safe Operating Area	RBSOA	$I_C = 120A$, $V_{CC} = 1050V$, $V_P = 1200V$, $V_{GE} = 15V$, $R_G = 50\Omega$, $T_j = 175^{\circ}C$	FULL SQUARE		-	
Short Circuit Withstand Time	t _{sc}	$V_{CC} \le 600V$, $V_{GE} = 15V$, $T_j = 25^{\circ}C$	10	-	-	μs
Short Circuit Withstand Time	t _{sc} *2	$V_{CC} \le 600V$, $V_{GE} = 15V$, $T_j = 150$ °C	8	-	-	μs

^{*2} Design assurance without measurement

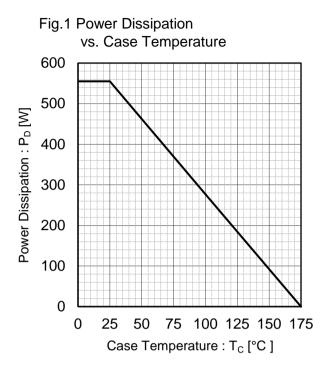


Fig.2 Collector Current vs. Case Temperature 100 80 Collector Current : Ic [A] 60 40 20 T_i ≤ 175°C , G_E ≥ 15V 0 25 75 100 125 150 175 0 Case Temperature : T_C [°C]

Fig.3 Forward Bias Safe Operating Area 1000 10µs 100 Collector Current : I_C [A] 10 100µs 1 0.1 T_C = 25°C Single Pulse 0.01 10 100 1000 10000 Collector To Emitter Voltage: V_{CE} [V]

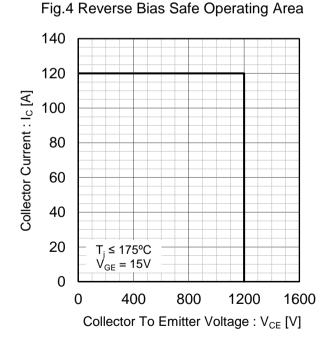


Fig.5 Typical Output Characteristics

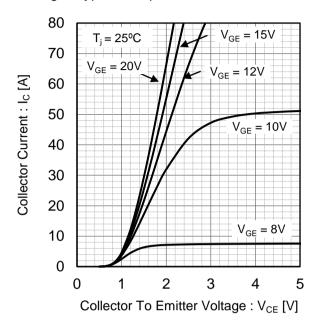


Fig.6 Typical Output Characteristics

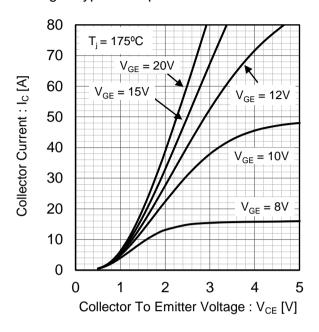


Fig.7 Typical Transfer Characteristics

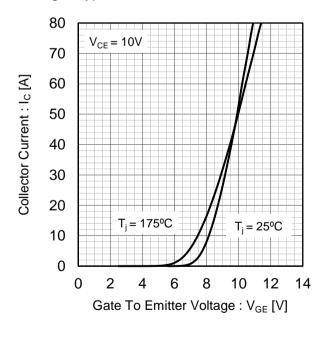
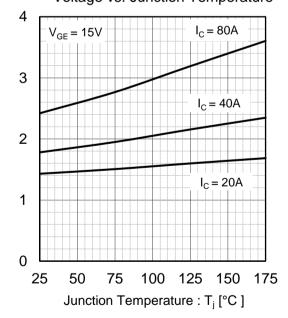


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature



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Collector To Emitter Saturation Voltage

: $V_{CE(sat)}[V]$

Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

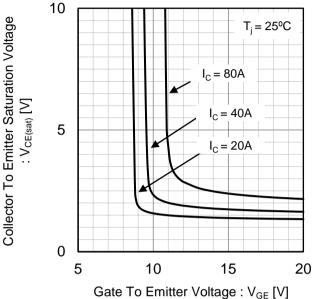


Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

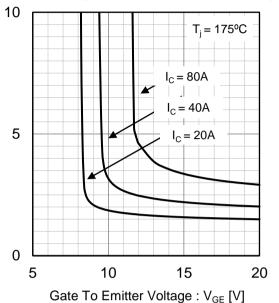


Fig.11 Typical Switching Time vs. Collector Current

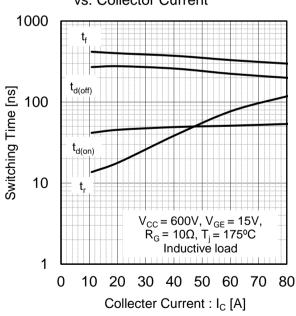
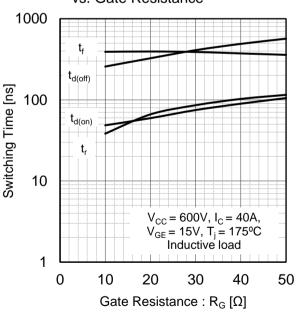


Fig.12 Typical Switching Time vs. Gate Resistance



Collector To Emitter Saturation Voltage

: V_{CE(sat)} [V]

Fig.13 Typical Switching Energy Losses vs. Collector Current

100 E_{off} $V_{cc} = 600V, V_{gE} = 15V, R_{g} = 10\Omega, T_{j} = 175^{\circ}C$ Inductive load

0.1

0 10 20 30 40 50 60 70 80

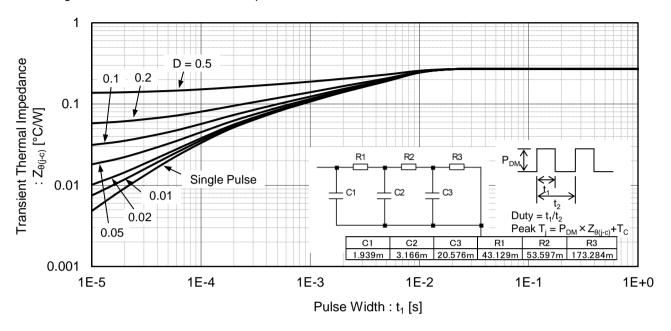
Collector Current : I_{c} [A]

Fig.14 Typical Switching Energy Losses vs. Gate Resistance 100 Switching Energy Losses [mJ] 10 $\mathsf{E}_{\mathsf{off}}$ Eon 1 V_{CC} = 600V, I_{C} = 40A, V_{GE} = 15V, T_{j} = 175°C Inductive load 0.1 0 10 20 30 40 50 Gate Resistance : $R_G[\Omega]$

Fig.15 Typical Capacitance vs. Collector To Emitter Voltage 10000 Cies 1000 Capacitance [pF] C_{oes} 100 10 $\mathsf{C}_{\mathsf{res}}$ f = 1MHz $V_{GE} = 0V$ T_i = 25°C 1 0.01 0.1 1 10 100 Collector To Emitter Voltage: V_{CE} [V]

Fig.16 Typical Gate Charge 15 Gate To Emitter Voltage: VGE [V] $V_{CE} = 300V$ 10 $V_{CE} = 500V$ 5 $I_C = 40A$ T_i = 25°C 0 0 30 60 90 120 Gate Charge : Qg [nQ]

Fig.17 IGBT Transient Thermal Impedance



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●Inductive Load Switching Circuit and Waveform

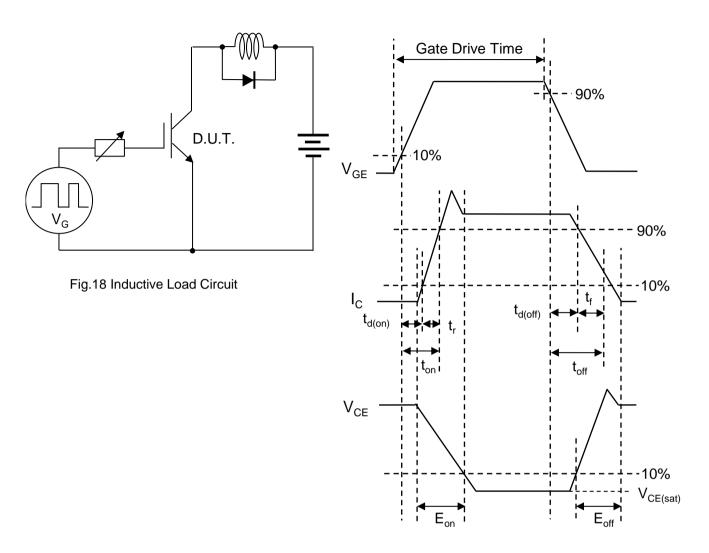


Fig.19 Inductive Load Waveform

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